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- A process for producing polymeric constituents, 1. including the steps of:
  - preparing a polymeric substrate which (a) depressions on at least one surface,
    - applying a polymeric covering to a surface (b) and having substrate the present\_ <u>\_\_on\_</u>

depressions,

substrate with the the heating (c) present | thereupon to a temperature which is least as high as the glass transition temperature of the substrate or/and of the covering, and

cooling (d) 15

> The process as claimed in claim 1, 2. wherein

the polymeric substrate and the polymeric covering are selected from the group consisting of acrylic 20 polymers, polycarbonates, polystyrenes, and also copolymers and mixtures of these.

The process as claimed in claim 2, 3.

wherein 25 the polymeric substrate and the polymeric covering are selected from the group consisting of acrylic polymers, in particular of polymethyl methacrylate polymers, or  $\phi$ f polymeric carbonates.

30 The process as claimed in any of claims 1 to 3, 4. wherein the substrate has depressions with a width or/and depth within the range from 10 nm to 2/mm.

The process as claimed in claim 4,, 5. wherein the substrate has depressions with a width or/and depth within the range from 100 nm to 1 mm.

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The process as claimed in claim 5 6. wherein the substrate has depress for with a width or/and depth within the range frqm/1  $\mu m$  to 500  $\mu m$ . 5 The process as claimed in any of the preceding 7. claims, wherein substrate and covering are selected from among 10 polymeric materials of the same type. of the preceding The process as claimed in any 8. ISSTFEET GALDECK claims, wherein 15 at least the covering is selected from among optically transparen $\not\models$  materials. c/fimed in any, of the preceding The process 9. claims, 20 wherein the polymeric/covering and the substrate are combined by pressure. The process as  $\phi$  laimed in  $\phi$  aim 9, 25 10. wherein the pressure applied is within the range from 1 to  $1000 \text{ kg/cm}^2$ . as claimed in any of the preceding The process 30 11. claims, wherein the duration of heating is within the range from 0.5 to 3 h. 35 The process as claimed in any of the preceding 12. claims,

wherein

the heating temperature is not more than 5°C above the glass transition temperature.

13. The process as claimed in any of the preceding claims, wherein

the substrate and the covering present thereupon are held within the region of the heating temperature for a period of at least 15 min.

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14. The process as claimed in claim 13, wherein

the substrate and the covering present thereupon are held within the region of the heating temperature for a period of at least 30 min.

15. The process as claimed in claim 13 or 14, wherein

the holding temperature is within  $\pm 3\,^{\circ}\text{C}$  of the heating temperature.

16. The process as claimed in any of the preceding claims,

wherein

25 the duration of the cooling is at least 1 h.

17. The process as claimed in claims 16,
wherein

the duration of the cooling is at least 2 h./

18. The process as claimed in any of claims 1 to 15, wherein the duration of the cooling is up to 30 sec.

- 35 19. A polymeric constituent with hollow structures present therein, obtainable by a process as claimed in any of claims 1/to 18.
  - 20. A polymeric component as claimed in claim 19,

wherein

the hollow structures comprise closed channels with a width or/and depth of from 10 nm to 10 mm.

5 21. A polymeric component as claimed in claim 19 or 20,

wherein

the interior of the component is free from

adhesives.

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22. The use of polymeric components as claimed in any of claims 19 to 21 in detection procedures, in particular in optical or/and electrical detection procedures.

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